



IFW 2814

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No. : 10/527,778
Applicant : E. Wolternik et al.
Filed : March 14, 2005
TC/A.U. : 2814
Examiner : Nhan T. Tran

Confirmation No.: 1800

Title : Camera Device, Method Of Manufacturing
A Camera Device, Wafer Scale Package

Docket No. : ALG10220P00110US
Customer No. : 32116

Commissioner For Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

AMENDMENT

Sir:

In response to the Office Action of December 24, 2008, please amend the
above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page
two (2) of this paper.

Remarks/Arguments begin on page eight (8) of this paper.